

1N5158 thru 1N5160

(Formerly M4L3052 thru M4L3054)

1N5779 thru 1N5793

PNPN 4-LAYER DIODES

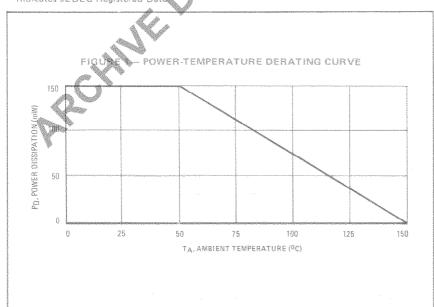
... two terminal, fast-switching devices specifically designed for low voltage applications such as logic circuits, pulse generators, memory and relay drivers, relay replacements, alarm circuits, multivibrators, ring counters, and telephone switching circuits. These devices feature:

- Low Breakover (Switching) Voltage 10 to 15-Volt Ratings
- Fast Switching Speeds $-t_{OR} = 75 \text{ ns (Typ)}$ $t_{Off} = 250 \text{ ns (Typ)}$
- Low Junction Capacitance 45 pF (Typ)
- Low Breakover Currents
- Subminiature Glass Package

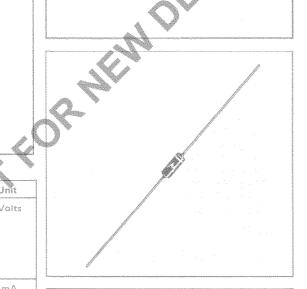
MAXIMUM RATINGS (TA = 25°C unless otherwise noted)

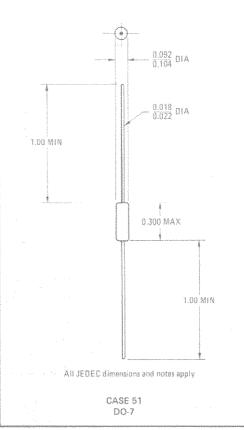
	Rating	Symbol	Value 🦸	Unit
*Reverse Voltage	1N5158, 1N5782, 1N5788 1N5159, 1N5783, 1N5789 1N5160, 1N5784, 1N5790 1N5779, 1N5785, 1N5791 1N5780, 1N5786, 1N5792 1N5781, 1N5787, 1N5793	VRM	10 11 12 13 14 15	Volts
*Continuous Forward Current		TAB.S	150	mΑ
*Steady State Pow Derate above 50	er Dissipation @ T _A - 50 ^G C		150 1.5	mW/°C
*Peak Pulse Currei (50 µs maximum		* ^I pulse	10	Amps
*Operating Junction	on Temperature Range	TJ	-65 to +150	°C
Storage Tempera	ture Range	Tstg	-65 to +175	°C

*Indicates JEDEC Registered Data







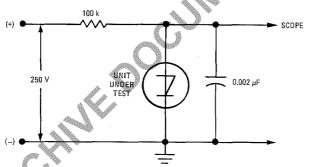


ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Тур	Max	Unit
*Forward Switching Voltage	1N5158, 1N5782, 1N5788	Vs	8.0	_	10	Volts
	1N5159, 1N5783, 1N5789		9.0	_	11	
	1N5160, 1N5784, 1N5790		10	_	12	
	1N5779, 1N5785, 1N5791		11	-	13	
	1N5780, 1N5786, 1N5792		12	_	14	4
	1N5781, 1N5787, 1N5793		13	_	15	
*Forward Switching Current	1N5158 thru 1N5160, 1N5779 thru 1N5781	Is	_	5.0	50	μΑ
	1N5782 thru 1N5793			10	100	
*Forward Off-State Current		IFM	. —	1.0	5.0	μΑ
$(V_F = 0.75 \times V_S)$						
*Reverse Current		IBM	_	2.0	10	μА
$(V_R = V_{RM})$		and the same of th		. 1		
*Holding Current	1N5158 thru 1N5160, 1N5779	Iн	1.0	4.0	20	mA
	thru 1N5781					
	1N5782 thru 1N5787		10	(-)	50	
	1N5788 thru 1N5793		0.1	- \ -	2.0	
*Forward On Voltage		VF		1.0	1.5	Volts
(I _F = 150 mAdc)						
*Critical Rate of Rise of Applied Forward Voltage		dv/dt	7			V/µs
(V _S = 6.0 Vdc)	1N5158, 1N5782, 1N5788		4	-	0.1	
$(V_S = 6.75 \text{ Vdc})$	1N5159, 1N5783, 1N5789		_		0.1	
(V _S = 7.5 Vdc)	1N5160, 1N5784, 1N5790		_	_	0.1	
(V _S = 8.25 Vdc)	1N5779, 1N5785, 1N5791		_		0.1	
$(V_S = 9.0 \text{ Vdc})$	1N5780, 1N5786, 1N5792		-	_	0.1	
$(V_S = 9.75 Vdc)$	1N5781, 1N5787, 1N5793		_		0.1	
Junction Capacitance		ر C	_	45	_	pF
(AC Voltage = 10 mV, V _F = 0	, f = 100 kHz)	*				
Turn-On Time (Figure 2)		ton	_	75(1)	_	ns
Turn-Off Time (Figure 3)		toff	_	250(1)		ns

^{*}Indicates JEDEC Registered Data. (1) Time depends on a wide variety of circuit conditions. Consult manufacturer for further information.

FIGURE 2 - TURN-ON TIME TEST CIRCUIT



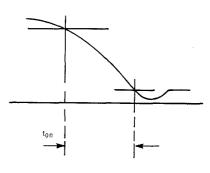
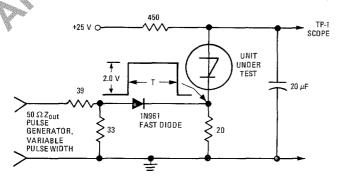
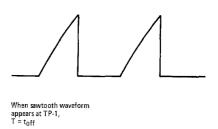


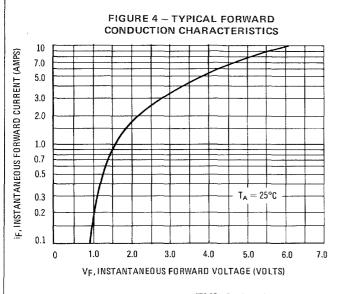
FIGURE 3 - TURN-OFF TIME TEST CIRCUIT

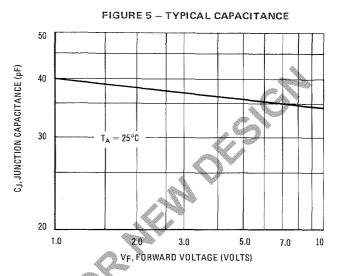




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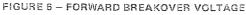


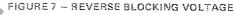


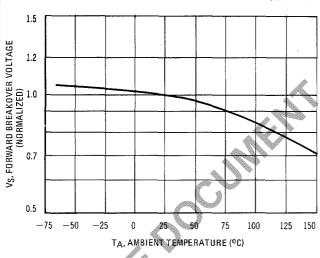


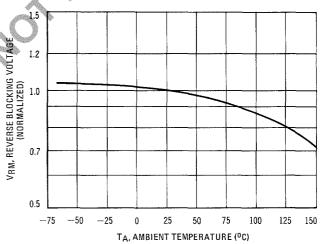
TYPICAL DC CHARACTERISTICS versus TEMPERATURE

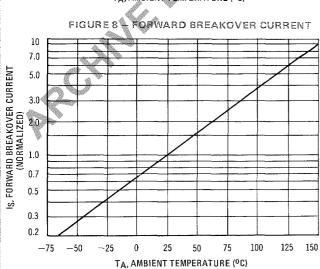
(NORMALIZED to 25°C VALUE)

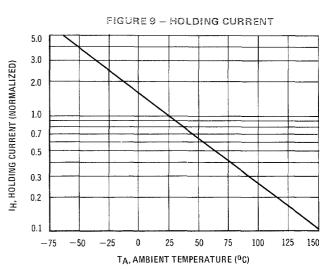








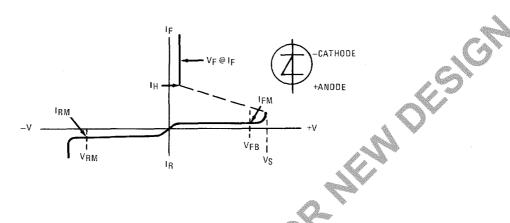




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4-LAYER DIODE SYMBOLS AND DEFINITIONS



dv/dt FORWARD VOLTAGE APPLICATION RATE (V/ μ s) – The rate of rise of forward voltage.

IS FORWARD BREAKOVER (SWITCHING) CURRENT —
The value of anode current at the instant the device switches from the blocking to the "on" state, specified at a particular junction temperature.

FORWARD CURRENT — The continuous or DC value of forward current during the "on" state.

IFM PEAK FORWARD BLOCKING CURRENT — The peak anode current when the 4-layer diode is in the "off" state for a stated anode-to-cathode voltage and junction temperture.

IH HOLDING CURRENT — That value of forward anode current below which the 4-layer diode switches from the conducting state to the forward blocking condition.

PEAK PULSE CURRENT — The peak repetitive current that can flow through the device for the time duration stated.

IRM PEAK REVERSE BLOCKING CURRENT — The peak current when the 4-layer diode is in the reverse blocking state for a stated anode-to-cathode voltage and junction temperature.

STEADY STATE POWER DISSIPATION

TA AMBIENT TEMPERATURE

T JUNCTION TEMPERATURE

T_{stg} STORAGE TEMPERATURE

TURN-ON TIME – The time interval between the 90% point (90% of forward blocking voltage) and the point 10% above the "on" voltage under stated conditions.

toff

TURN-OFF TIME — The time interval required for the device to regain control of its forward blocking characteristic after interruption of forward anode current.

Vs FORWARD BREAKOVER (SWITCHING) VOLTAGE —
The positive anode voltage with respect to cathode required to switch the device from the high impedance blocking state to the low impedance "on" state, specified at a particular junction temperature.

V_F FORWARD VOLTAGE — The forward voltage across the device in the "on" state under stated conditions of current and temperature.

V_{FB} FORWARD BLOCKING VOLTAGE – The anode-to-cathode voltage when the 4-layer diode is in the "off" state.

PEAK REVERSE VOLTAGE — The maximum allowable instantaneous value of reverse voltage (repetitive or continuous DC) which can be applied to the device at a stated temperature without damage to the device.

MECHANICAL CHARACTERISTICS

CASE: Hermetically sealed all glass case DIMENSIONS: JEDEC DO-7 Outline

FINISH: All external surfaces are corrosion resistant with readily solderable leads.

 v_{RM}

POLARITY: Cathode end indicated by color band.

WEIGHT: 0.2 grams (approx.) MOUNTING POSITION: Any



 P_{D}

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